

Figure 2: Numerical device physics simulations/ analytical calculations of barrier height for MIS diodes of different oxide thickness. ALD deposition is assumed to be 1 Å/cycle.

Figure 3: Measured barrier heights for different ALD cycles measured by current-voltagetemperature (IVT) and Mott-Schottky (M-S) methods. The 0 cycle ALD measurement is due to Fermi-level pinning. The As-Dep barrier height measured by IVT and all of the M-S data do not match the simulation/analytical data.